

650V N-Channel MOSFET

Description

The MSU4N65 is a N-channel enhancement-mode MOSFET , providing the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness. The TO-251 package is universally preferred for all commercial-industrial applications

Features

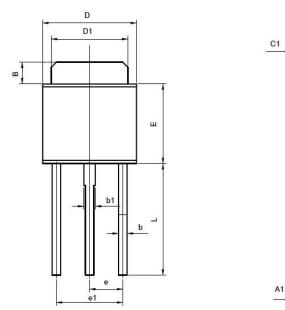
- Originative New Design
- 100% EAS Test
- Rugged Gate Oxide Technology
- Extremely Low Intrinsic Capacitances
- Remarkable Switching Characteristics
- Unequalled Gate Charge : 15 nC (Typ.)
- Extended Safe Operating Area
- Lower RDS(ON) : 2.4 Ω (Typ.) @VGS=10V
- RoHS compliant package

Packing & Order Information

80/Tube ; 4,000/Box



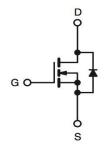




	Dimens	ions in	Dimensions in		
	Millimeters		Inches		
Symbol	min	max	min	max	
А	2.15	2.45	0.85	0.96	
A1	1.00	1.40	0.39	0.55	
В	1.25	1.75	0.49	0.69	
b	0.45	0.75	0.18	0.3	
b1	0.65	0.95	0.26	0.37	
С	0.38	0.64	0.15	0.25	
C1	0.38	0.64	0.15	0.25	
D	6.30	6.70	2.48	2.64	
D1	5.10	5.50	2.01	2.17	
E	5.30	5.70	2.09	2.24	
е	2.3 (typ.)		0.91 (t	yp.)	
e1	4.4	4.8	1.73	1.89	
L	7.4	8.0	2.91 3.15		

С

Graphic symbol





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MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)						
Symbol	Parameter	Value	Unit			
V _{DSS}	Drain-Source Voltage	650	V			
V _{GS}	Gate-Source Voltage	±30	V			
L	Drain Current -Continuous (TC=25°C)	3.6	А			
I _D	Drain Current -Continuous (TC=100°C)	2.3	А			
I _{DM}	Drain Current Pulsed	14.4	А			
E _{AS}	Single Pulsed Avalanche Energy	240	mJ			
E _{AR}	Repetitive Avalanche Energy	4.4	mJ			
dV/dt	Peak Diode Recovery dV/dt	5.5	V/ns			
_	Power Dissipation (TC = 25 °C)	55	W			
P _D	- Derate above 25°C	0.4	W/°C			
T_{J}, T_{STG}	Operating and Storage Temperature Range	-55 to +150	°C			
т	Maximum lead temperature for soldering purposes, 1/8" from	300	°C			
TL	case for 5 seconds	300	C			

•Drain current limited by maximum junction temperature

Thermal Resistance Characteristics					
Symbol	Parameter	Max.	Units		
R _{θJ} c	Junction-to-Case	2.5	0 0 AA/		
$R_{ extsf{ heta}JA}$	Junction-to-Ambient	110	- °C/W		

On Characteristics					
Symbol	Test Conditions	Min	Тур.	Max.	Units
V _{GS}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	2.0		4.0	V
*R _{DS(ON)}	$V_{GS} = 10 \text{ V}$, $I_D = 1.8 \text{ A}$		2.4	2.9	Ω

Off Characteristics					
Symbol	Test Conditions	Min	Тур.	Max.	Units
BV_{DSS}	$V_{GS} = 0 V$, $I_D = 250 \mu A$	650	710		V
$\Delta BV_{DSS} / \Delta T_{J}$	$I_D = 250 \mu A$, Referenced to 25°C		0.6		V/°C
I _{DSS}	$V_{DS} = 650 \text{ V}$, $V_{GS} = 0 \text{ V}$ $V_{DS} = 520 \text{ V}$, $V_{C} = 125^{\circ}\text{C}$			1 10	μA
I _{GSSF}	$V_{\rm GS}$ = 30 V , $V_{\rm DS}$ = 0 V			100	nA
I _{GSSR}	V_{GS} = -30 V , V_{DS} = 0 V			-100	nA



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Switching Characteristics					
Symbol	Test Conditions	Min	Тур.	Max.	Units
t _{d(on)}			10	20	ns
t _r	$V_{DS} = 325 V, I_D = 3.6 A,$		35	70	ns
t _{d(off)}	$R_G = 25 \Omega$		45	90	ns
tf			40	80	ns
Qg			15	20	nC
Q _{gs}	$V_{DS} = 520 \text{ V}, I_D = 3.6 \text{ A},$ $V_{GS} = 10 \text{ V}$		2.8		nC
Q _{gd}			6.0		nC
C _{ISS}			545	710	pF
C _{OSS}	$V_{DS} = 25 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ F = 1.0MHz		60	80	pF
C _{RSS}			8	11	pF

Source-Drain Diode Maximum Ratings and Characteristics						
Symbol	Parameter	Test Conditions	Min	Тур.	Max.	Units
I _S					3.6	
I _{SM}					16	- A
V _{SD}	$I_{S} = 3.6 \text{ A}$, $V_{GS} = 0 \text{ V}$				1.5	V
t _{rr}	$I_{S} = 3.6 \text{ A}$, $V_{GS} = 0 \text{ V}$			300		ns
Q _{rr}	diF/dt = 100A/µs			2.2		μC

Notes;

1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. I_{AS} =3.6A, V_{DD} =50V, R_{G} =25W, Starting T_{J} =25°C

3. $I_{SD} \leq 3.6A$, di/dt $\leq 300A/\mu s$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^{\circ}C$

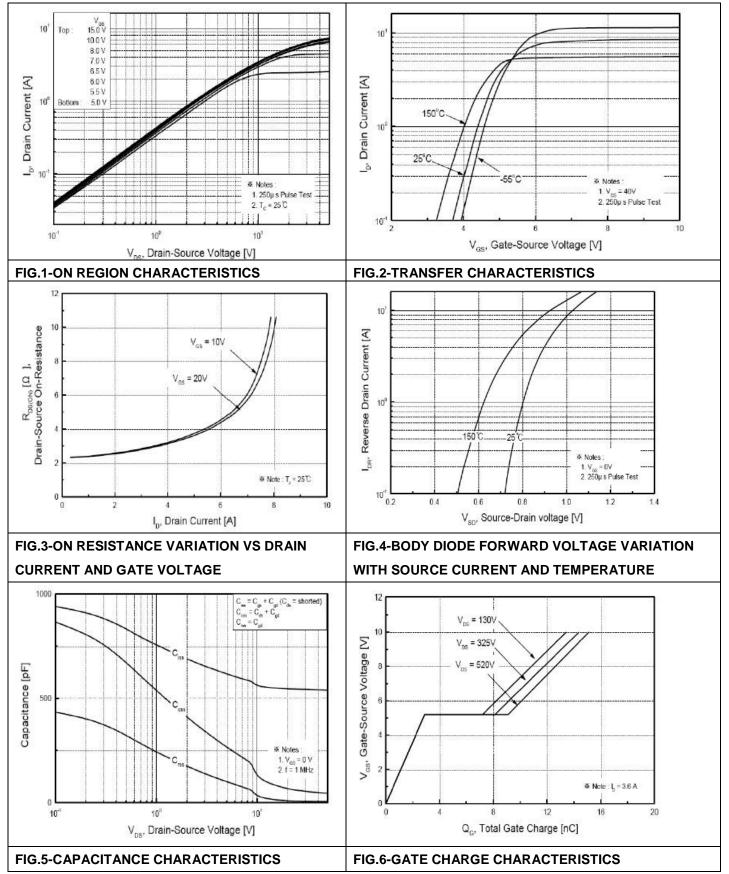
4. Pulse Test: Pulse Width ≦ 300µs, Duty Cycle≦ 2%

5. Essentially Independent of Operating Temperature



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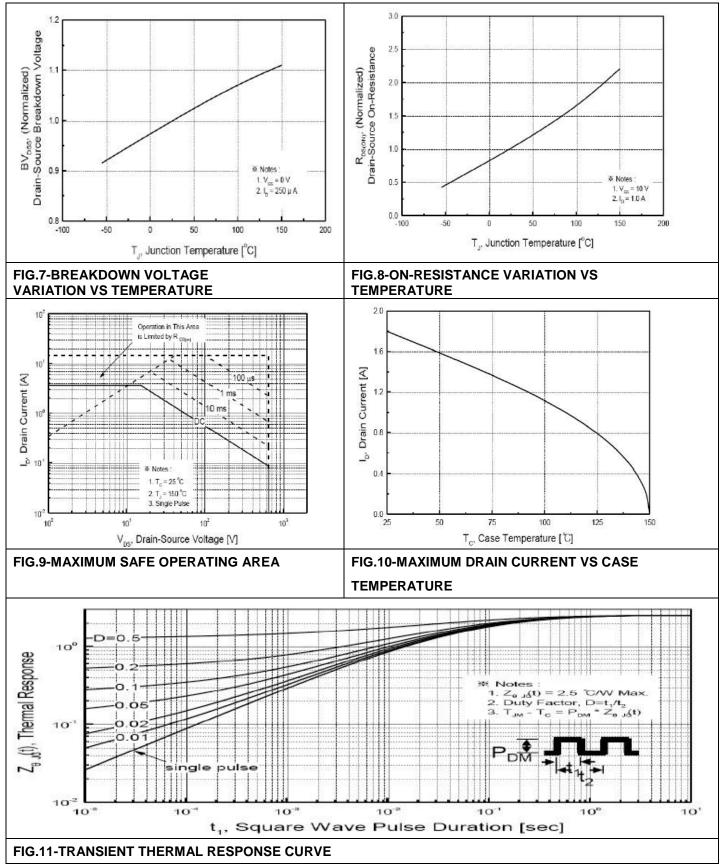
Characteristics Curve





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Characteristics Curve





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